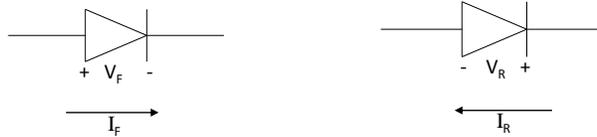


DIODO

Definición:

- Dispositivo Semiconductor
- Dos terminales
- Permite la Circulación de corriente (I) en un solo sentido

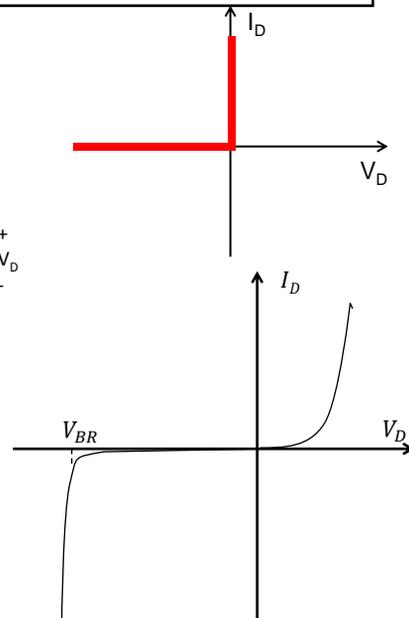
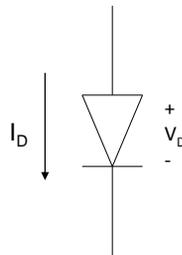
Símbolo y convenciones V - I:



DIODO Ideal vs. Semiconductor

DIODO IDEAL

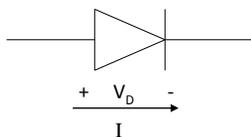
$$V_D > 0 \Rightarrow I_D \rightarrow \infty$$



DIODO Semiconductor

$$I_D = I_s [\exp (V_D/U_T) - 1]$$

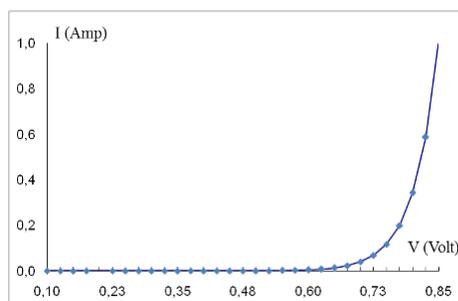
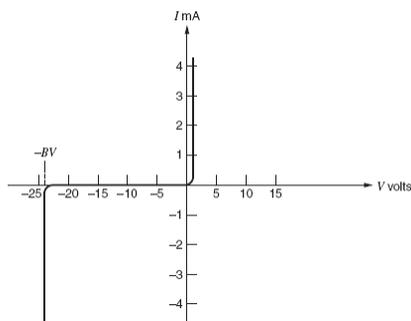
Relación V – I (Modelo Diodo Ideal)



$$I = I_s [\exp (V_D / U_T) - 1]$$

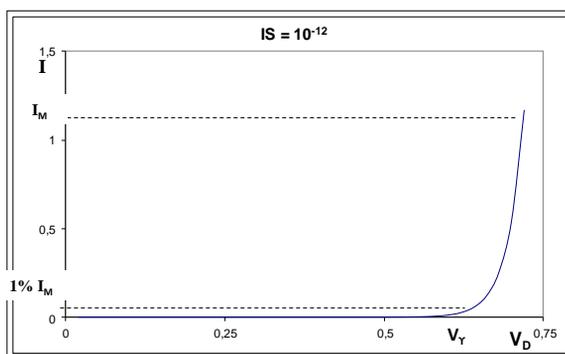
$I_s \longrightarrow$ Fabricación

$$U_T = k T / q$$



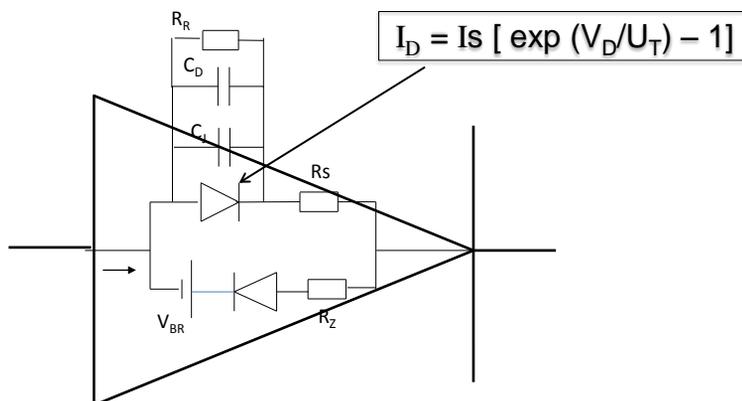
$$I = I_s [\exp (V_D / U_T) - 1]$$

- Dos diodos se diferencian entre si a través del valor de I_s
- I_s refleja el proceso de fabricación (material, concentraciones, dimensiones)
- I_s depende de la temperatura.
- La V_Y (Tensión umbral) se define como la tensión que produce el 1% del valor de corriente máxima que puede conducir el Diodo



Limitaciones del modelo del Diodo Semiconductor

- Resistencia serie (R_s)
- Máxima Tensión Inversa (V_{BR})
- Capacidad de Juntura (C_j)
- Capacidad de difusión (C_D)
- Generación en Zona de Deplexión
- Recombinación en Zona de Deplexión
- Máxima Temperatura de Juntura (T_{JM})
- Máxima Corriente Directa (I_{FM})



Generación en Zona de Deplexion

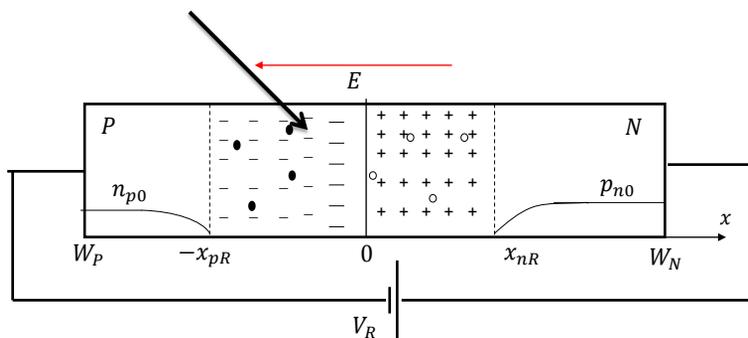


Corriente inversa mayor que I_s

Con polarización inversa en ZD el producto $p \times n < n_i^2$

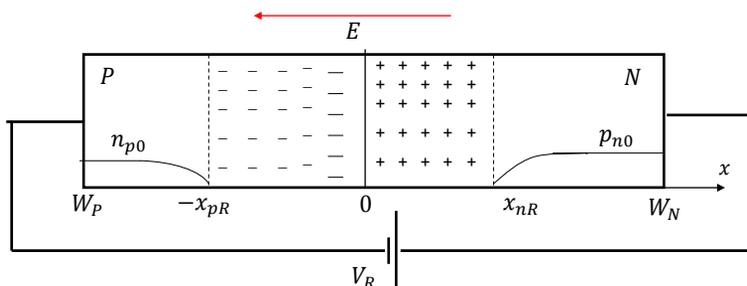


Tendencia a la Generación

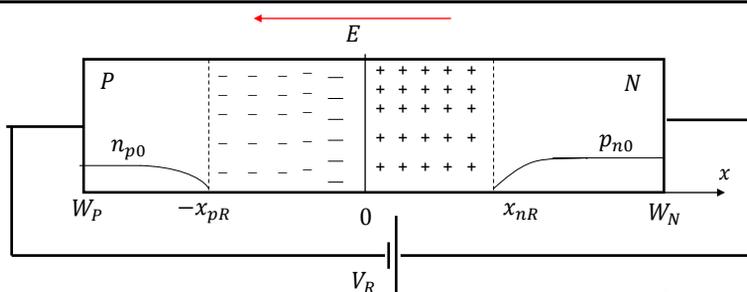


La corriente inversa medida es mayor que I_s

MAXIMA TENSION INVERSA



- Los portadores minoritarios que atraviesan la Zona de deplexion son acelerados por el campo.
- Al atravesar la ZD los portadores chocan con los átomos, en estos choques, si los portadores tienen la energía cinética suficiente, pueden liberar electrones de las ligaduras covalentes de los átomos. Estos electrones son nuevos portadores
- El proceso de generación de portadores por choque en la ZD se llama "Avalancha" y se produce cuando el campo (E_{MAX}) en la ZD alcanza el valor necesario para que la energía cinética de los portadores produzca la liberación de electrones de las ligaduras covalentes



Campo eléctrico en $x = 0$ \longrightarrow
$$E_{MAX} = \left(\frac{2qN_A N_D}{\epsilon(N_A + N_D)} \right)^{1/2} (V_R + V_{j0})^{1/2}$$

Valor del campo eléctrico para el que comienza el proceso de "Avalancha" \longrightarrow
$$E_{critico} = \frac{4 \times 10^5}{1 - \frac{1}{3} \log \left(\frac{N}{10^{16}} \right)}$$

Cuando $\rightarrow E_{MAX} \geq E_{critico} \rightarrow$ Avalancha en la ZD

La tensión V_R que hace que $E_{MAX} = E_{critico}$

Es $V_{BR} \rightarrow$ Máxima tensión de bloqueo inversa

- Al aumentar la temperatura disminuye λ (camino libre medio)
- Esta disminución de λ (camino libre medio) implica una disminución de la energía cinética que adquieren los portadores antes de chocar
- Para compensar esta disminución de la energía cinética debo aumentar el campo que acelera los portadores
- Por tanto el aumento de temperatura hace necesario un campo mayor para provocar la avalancha

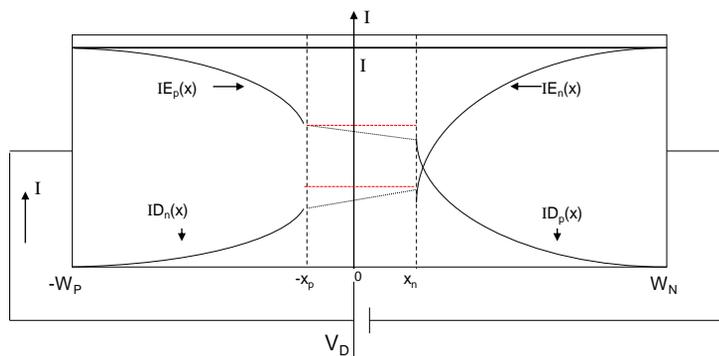
$T \uparrow \Rightarrow V_{BR} \uparrow \longrightarrow$ Para AVALANCHA

- Ruptura Zener

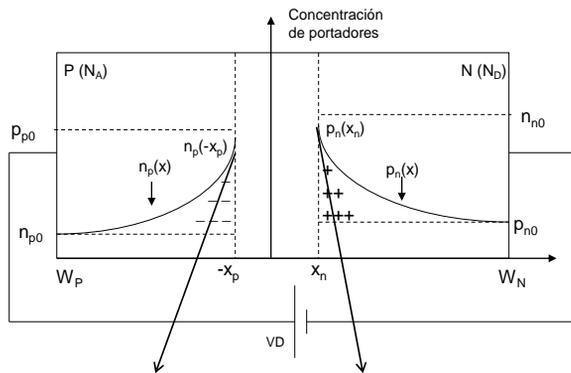
Recombinación en zona de deplexion

$$I = I_s \left[\exp \left(\frac{V_D}{\eta U_T} \right) - 1 \right]$$

$\eta \cong 2$
Para Si

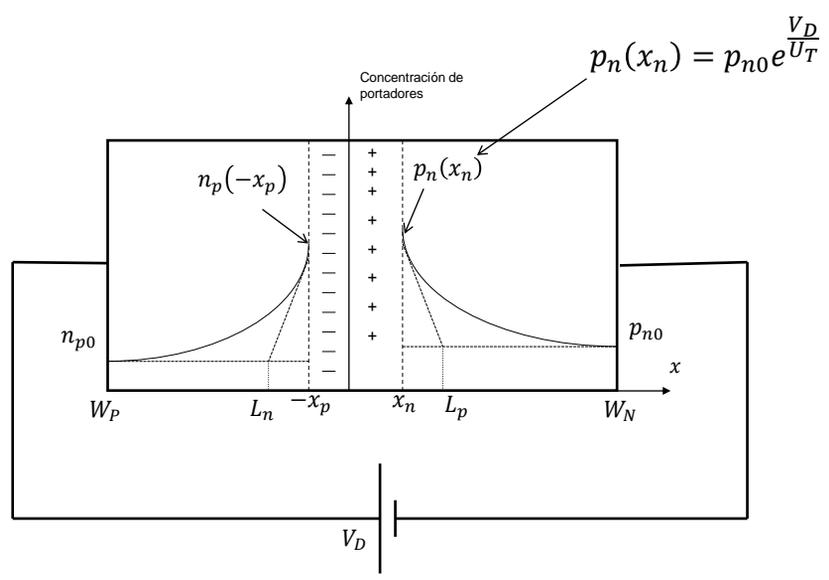


Inyección de Alto Nivel



Cuando $n_p(-x_p) \cong p_{p0}$ o $p_n(x_n) \cong n_{n0}$
 Se produce la ruptura de la neutralidad eléctrica
 El campo se opone al paso de los portadores
 La corriente disminuye

$$I = I_s \left[\exp \left(\frac{V_D}{\eta U_T} \right) - 1 \right]$$



$$p_n(x_n) = n_{n0} = N_D$$

$$p_n(x_n) = p_{n0} e^{\frac{V_D}{U_T}} \quad p_{n0} = \frac{n_i^2}{N_D} \quad p_n(x_n) = \frac{n_i^2}{N_D} e^{\frac{V_D}{U_T}}$$

Condición de inyección de alto nivel



$$p_n(x_n) = n_{n0} = N_D$$

$$N_D = \frac{n_i^2}{N_D} e^{\frac{V_D}{U_T}}$$

TENSION DE POLARIZACION A LA QUE COMIENZA LA INYECCION DE ALTO NIVEL



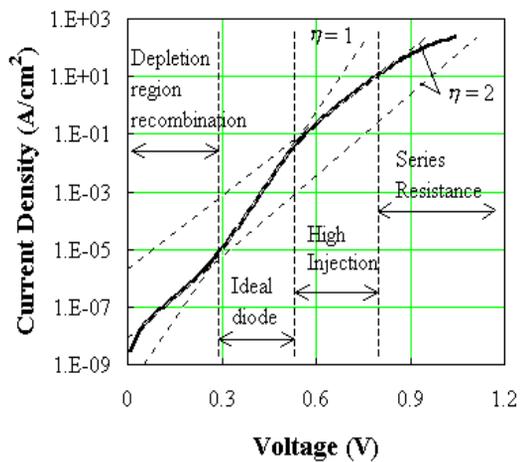
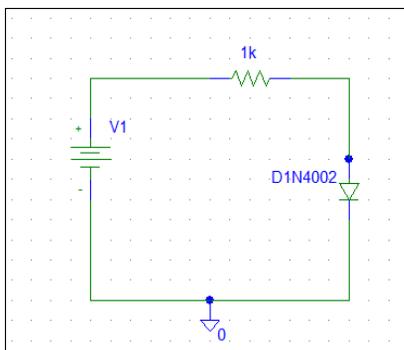
$$V_D = 2U_T \ln \frac{N_D}{n_i}$$

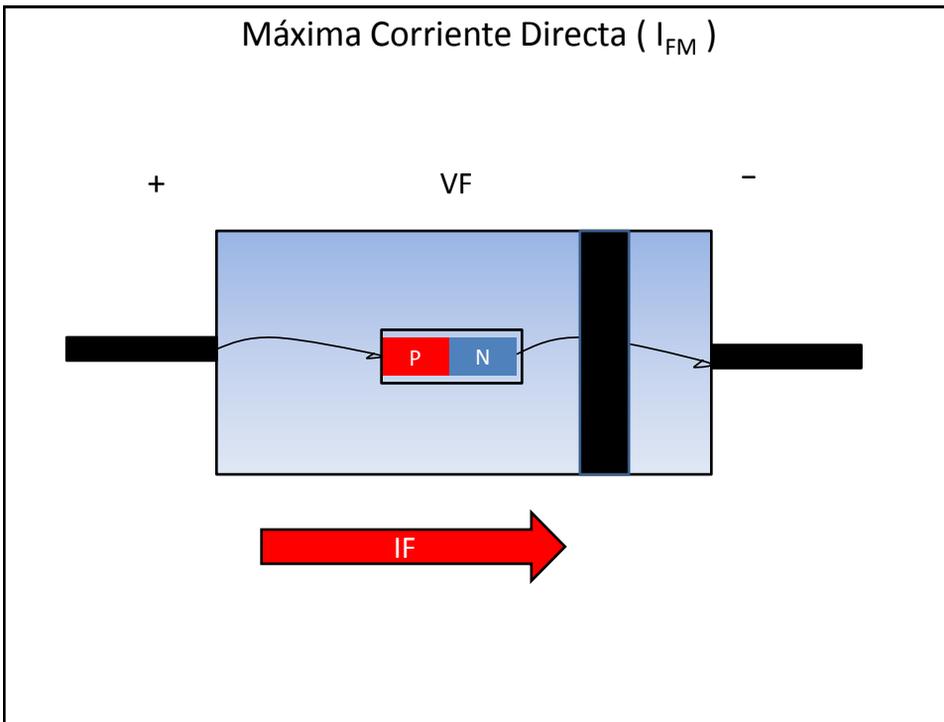
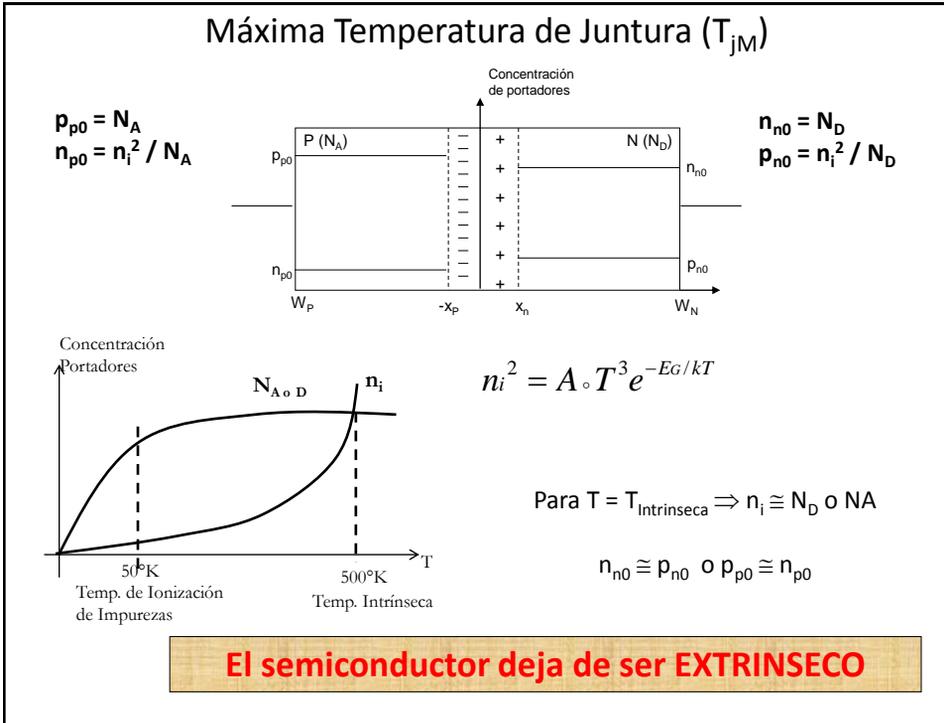
Ejemplo: Juntura N⁺P con $N_A = 10^{17}$ $N_D = 10^{15}$ $T = 300$ °K

$$V_D = 2 \times 0,026 \ln \frac{10^{15}}{10^{10}} = 0,598 \text{ V}$$

$$I = I_s \left[\exp \left(\frac{V_D}{\eta U_T} \right) - 1 \right]$$

$$\ln \frac{I}{I_s} = \frac{V_D}{\eta U_T}$$





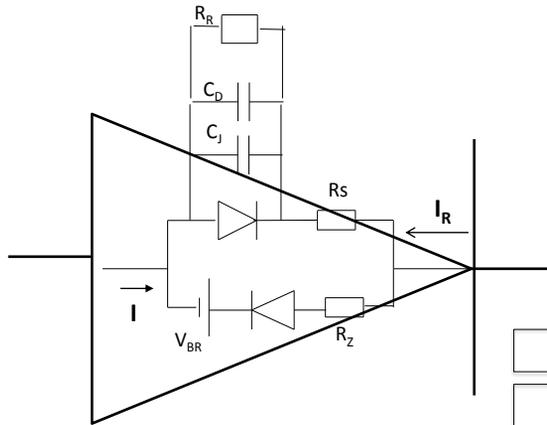
MODELO DEL DIODO

$$I = I_s \left[\exp \left(\frac{V_D}{\eta U_T} \right) - 1 \right]$$

$$I_R = M I_s$$

$$n \sim 3 \text{ a } 6$$

$$M = \frac{1}{1 - \left(\frac{V_R}{V_{BR}} \right)^n}$$



$$C_j = \frac{C_{j0}}{\sqrt[m]{1 + \frac{V_R}{V_{j0}}}}$$

$m = 2 \rightarrow$ Junt. abrupta

$m = 3 \rightarrow$ Junt. gradual

$$C_D = T_T \frac{I}{U_T}$$

PARAMETROS DEL MODELO

 I_s
 R_s
 V_{BR}
 C_{j0}
 T_T
 η
 V_{j0}

ECUACIONES DEL MODELO

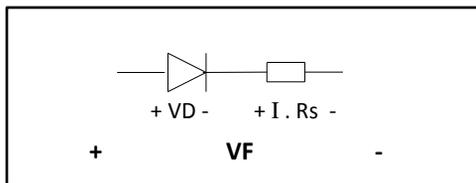
$$I = I_s \left[\exp \left(\frac{V_D}{\eta U_T} \right) - 1 \right]$$

$$I_R = M I_s$$

$$M = \frac{1}{1 - \left(\frac{V_R}{V_{BR}} \right)^n}$$

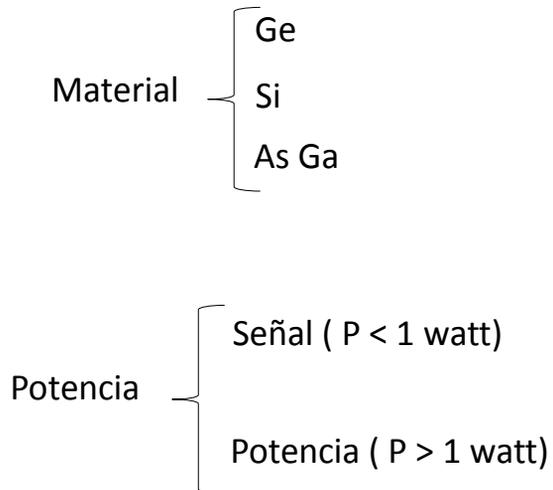
$$C_j = \frac{C_{j0}}{\sqrt{1 + \frac{V_R}{V_{j0}}}}$$

$$C_D = T_T \frac{I_D}{U_T}$$

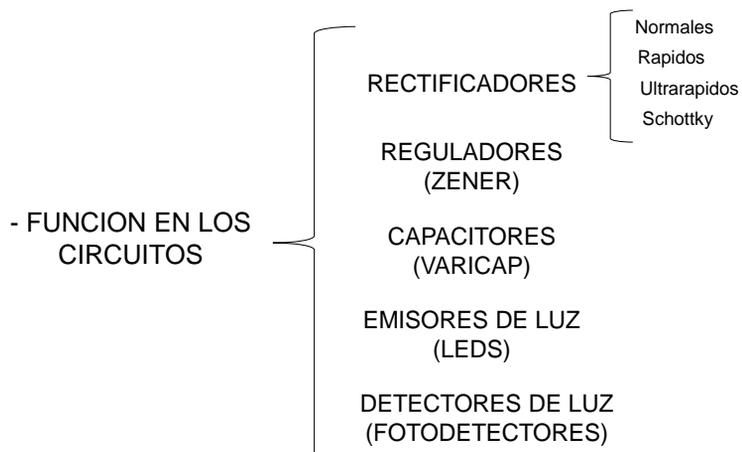


$$V_F = V_D + I \cdot R_s$$

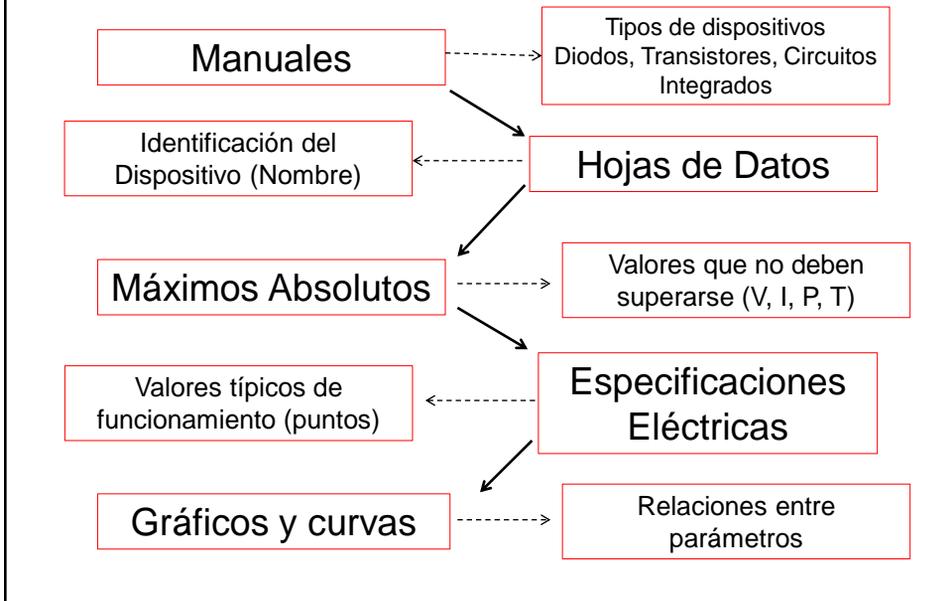
CLASIFICACION DE LOS DIODOS



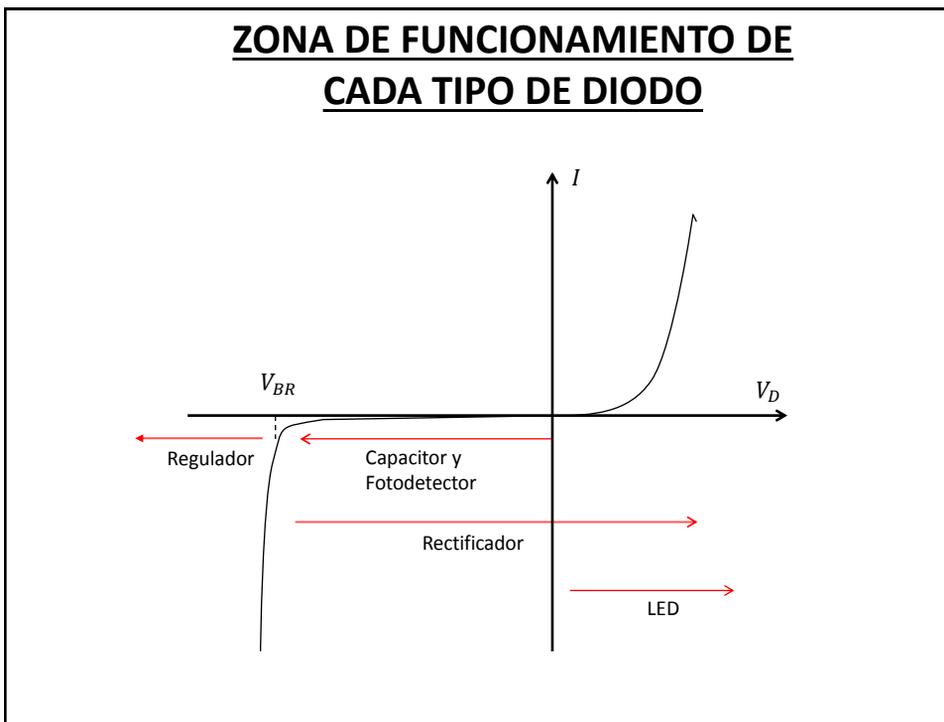
CLASIFICACION DE LOS DIODOS

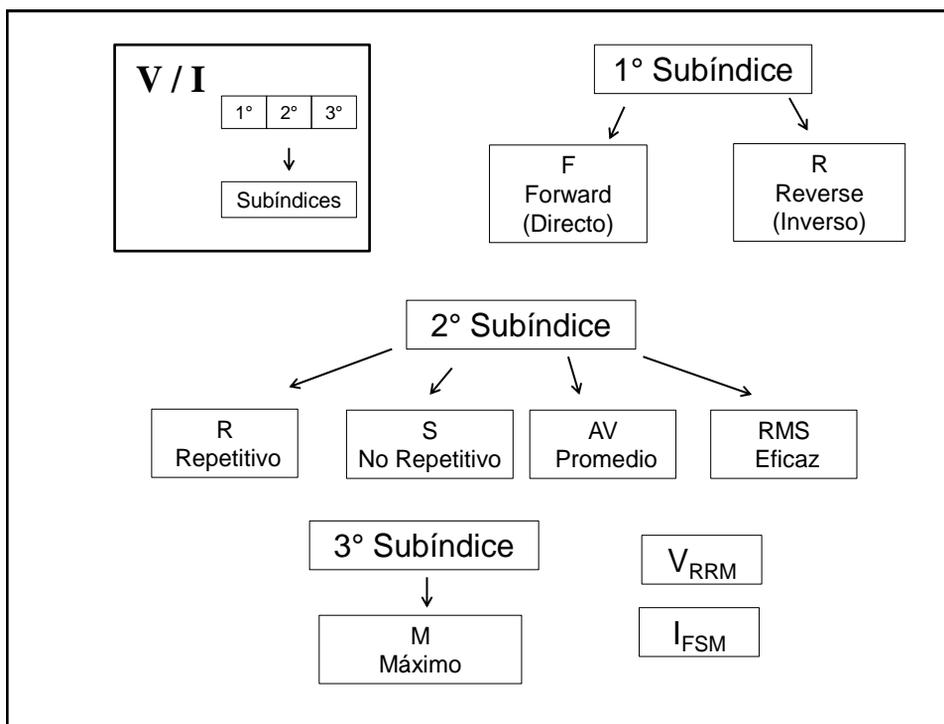
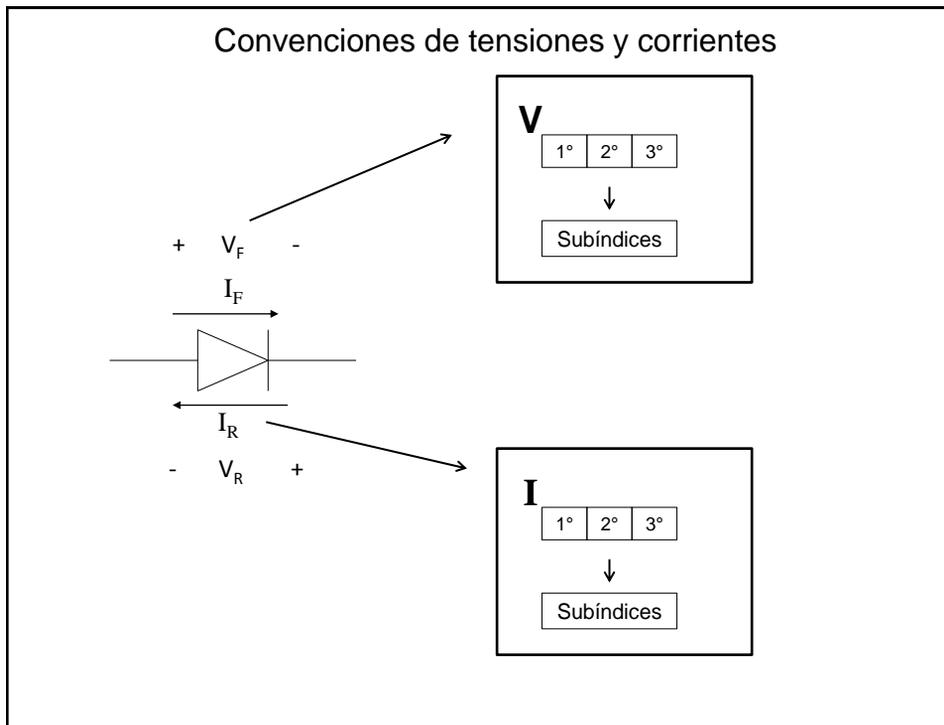


ESPECIFICACION DE DISPOSITIVOS SEMICONDUCTORES



ZONA DE FUNCIONAMIENTO DE CADA TIPO DE DIODO







1N4001 - 1N4007

Features

- Low forward voltage drop.
- High surge current capability.



DO-41

COLOR BAND DENOTES CATHODE

General Purpose Rectifiers (Glass Passivated)

Absolute Maximum Ratings*

$T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value							Units
		4001	4002	4003	4004	4005	4006	4007	
V_{RRM}	Peak Repetitive Reverse Voltage	50	100	200	400	600	800	1000	V
$I_{F(AV)}$	Average Rectified Forward Current, .375" lead length @ $T_A = 75^\circ\text{C}$	1.0							A
I_{FSM}	Non-repetitive Peak Forward Surge Current 8.3 ms Single Half-Sine-Wave	30							A
T_{stg}	Storage Temperature Range	-55 to +175							$^\circ\text{C}$
T_J	Operating Junction Temperature	-55 to +175							$^\circ\text{C}$

*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Electrical Characteristics

$T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Device							Units
		4001	4002	4003	4004	4005	4006	4007	
V_F	Forward Voltage @ 1.0 A	1.1							V
I_{rr}	Maximum Full Load Reverse Current, Full Cycle $T_A = 75^\circ\text{C}$	30							μA
I_R	Reverse Current @ rated V_R $T_A = 25^\circ\text{C}$ $T_A = 100^\circ\text{C}$	5.0 500							μA μA
C_T	Total Capacitance $V_R = 4.0\text{ V}$, $f = 1.0\text{ MHz}$	15							pF

Thermal Characteristics

Symbol	Parameter	Value	Units
P_D	Power Dissipation	3.0	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	50	$^{\circ}C/W$

Typical Characteristics

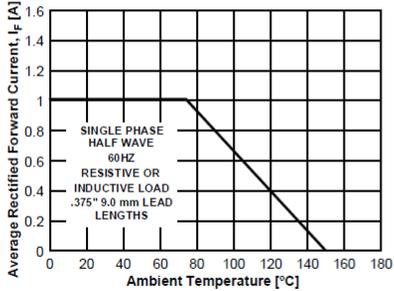


Figure 1. Forward Current Derating Curve

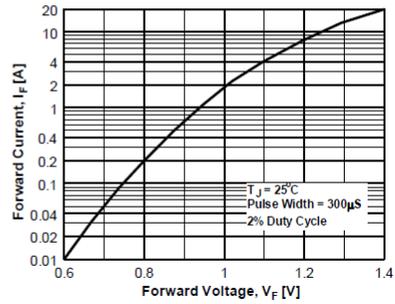


Figure 2. Forward Voltage Characteristics

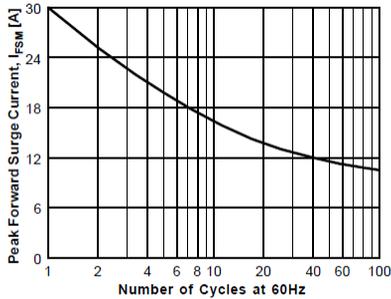


Figure 3. Non-Repetitive Surge Current

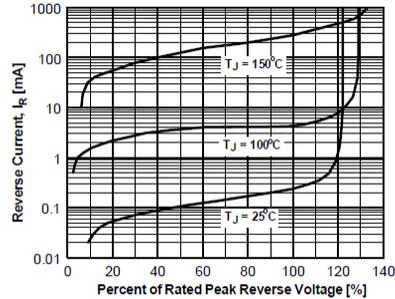


Figure 4. Reverse Current vs Reverse Voltage

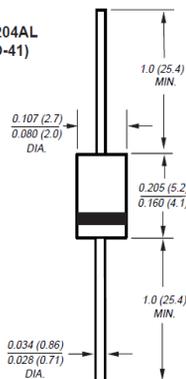


1N4001 thru 1N4007

Vishay Semiconductors
formerly General Semiconductor



DO-204AL
(DO-41)



NOTE: Lead diameter is 0.026 (0.66) / 0.023 (0.58) for suffix "E" part numbers

Reverse Voltage
50 to 1000V
Forward Current 1.0A

Features

- Plastic package has Underwriters Laboratories Flammability Classification 94V-0
- Construction utilizes void-free molded plastic technique
- Low reverse leakage
- High forward surge capability
- High temperature soldering guaranteed: 350°C/10 seconds, 0.375" (9.5mm) lead length, 5 lbs. (2.3kg) tension

Mechanical Data

Case: JEDEC DO-204AL, molded plastic body

Terminals: Plated axial leads, solderable per MIL-STD-750, Method 2026

Polarity: Color band denotes cathode end

Mounting Position: Any

Weight: 0.012 oz., 0.3 g

Maximum Ratings & Thermal Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	Symb.	1N 4001	1N 4002	1N 4003	1N 4004	1N 4005	1N 4006	1N 4007	Unit
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	V
* Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	V
* Maximum DC blocking voltage	V _{DC}	50	100	200	400	600	800	1000	V
* Maximum average forward rectified current 0.375" (9.5mm) lead length at T _A = 75°C	I _{F(AV)}	1.0							A
* Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method) T _A = 75°C	I _{FSM}	30							A
* Maximum full load reverse current, full cycle average 0.375" (9.5mm) lead length T _L = 75°C	I _{R(AV)}	30							μA
Typical thermal resistance ⁽¹⁾	R _{θJA} R _{θJL}	50 25							°C/W
* Maximum DC blocking voltage temperature	T _A	+150							V
* Operating junction and storage temperature range	T _J , T _{STG}	-50 to +175							°C

Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	Symb.	Value	Unit
Maximum instantaneous forward voltage at 1.0A	V _F	1.1	V
* Maximum DC reverse current at rated DC blocking voltage T _A = 25°C T _A = 125°C	I _R	5.0 50	μA
Typical junction capacitance at 4.0V, 1MHz	C _J	15	pF

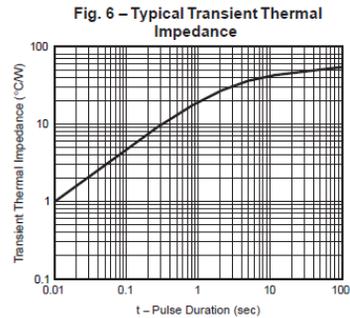
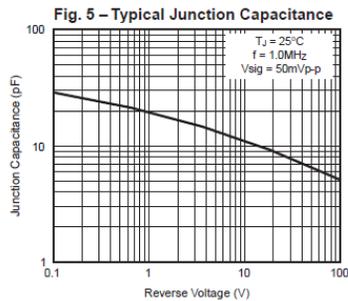
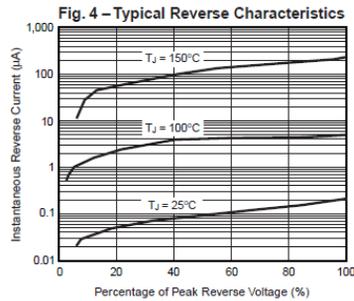
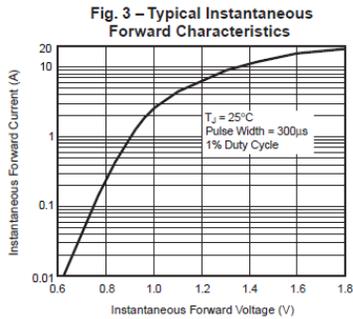
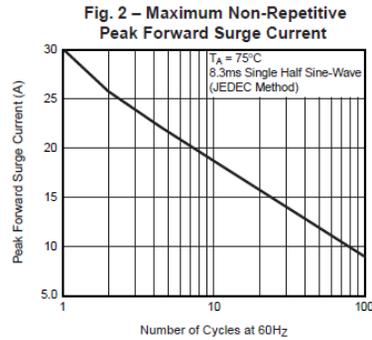
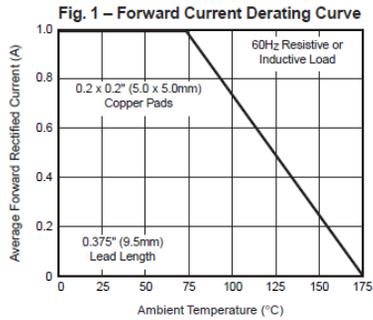
Note: (1) Thermal resistance from junction to ambient at 0.375" (9.5mm) lead length, P.C.B. mounted *JEDEC registered values

1N4001 thru 1N4007

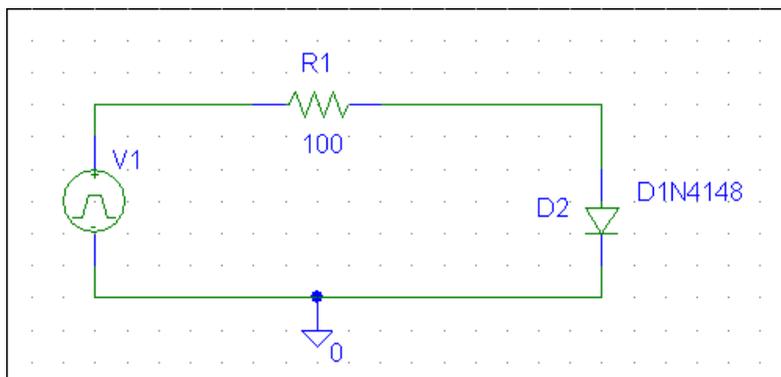
Vishay Semiconductors
formerly General Semiconductor



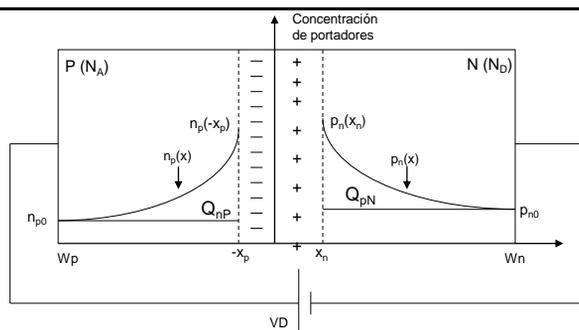
Ratings and Characteristic Curves (T_A = 25°C unless otherwise noted)



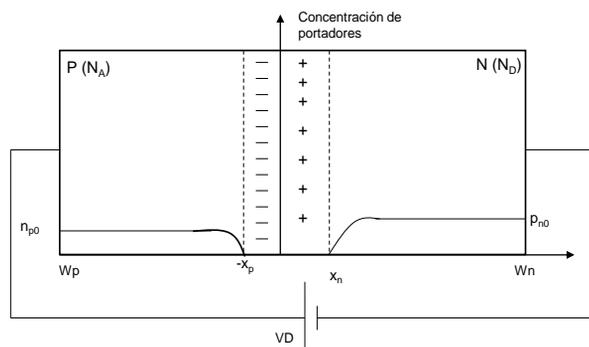
Tiempo de recuperación t_{rr}



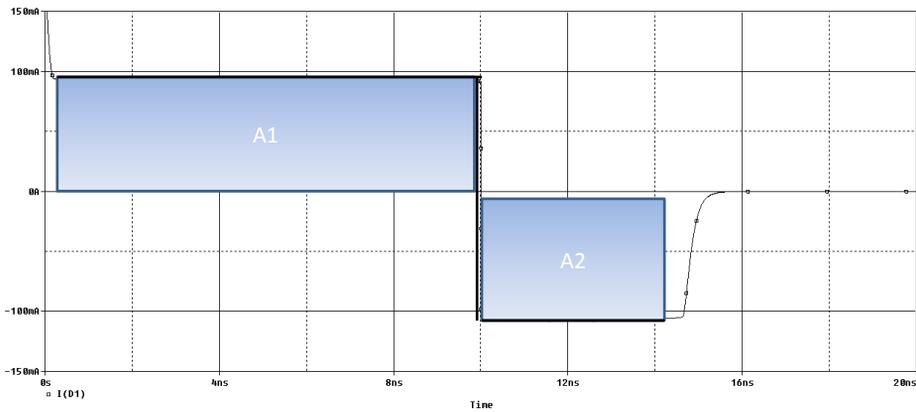
D
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A



MAXIMA FRECUENCIA DE RECTIFICACION



Debe ser $A_1 \gg A_2$

$$\frac{T}{2} \gg t_{rr}$$

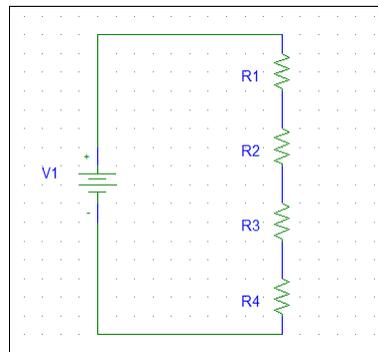
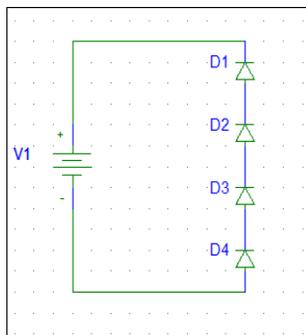
$$\frac{T}{2} = 10t_{rr}$$

$$T = 20t_{rr}$$

$$f = \frac{1}{T}$$

$$f_{max} \leq \frac{1}{20t_{rr}}$$

DIODOS SERIE

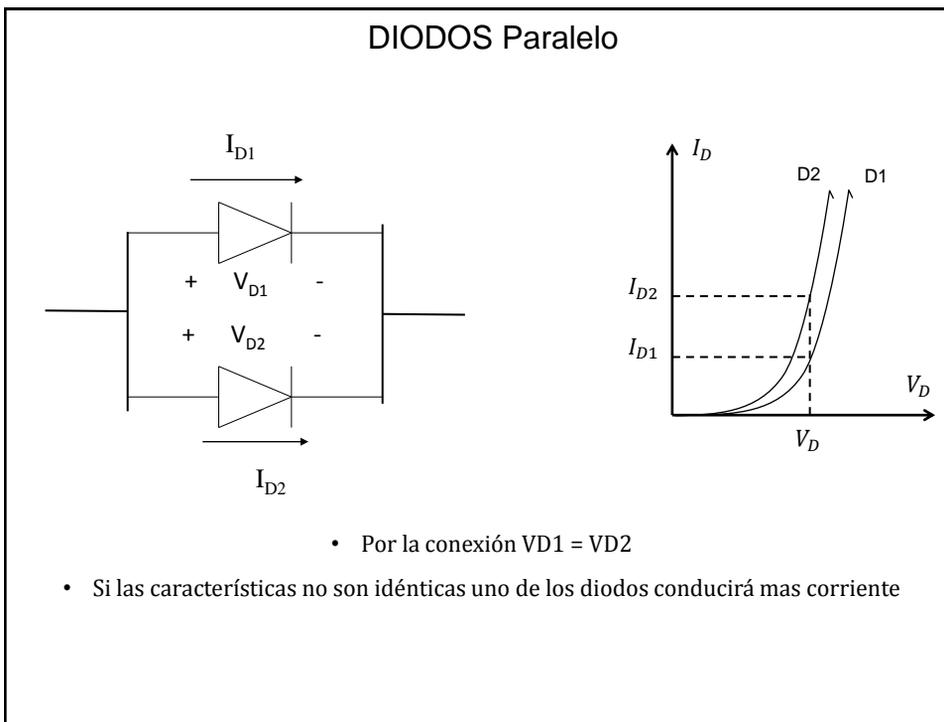
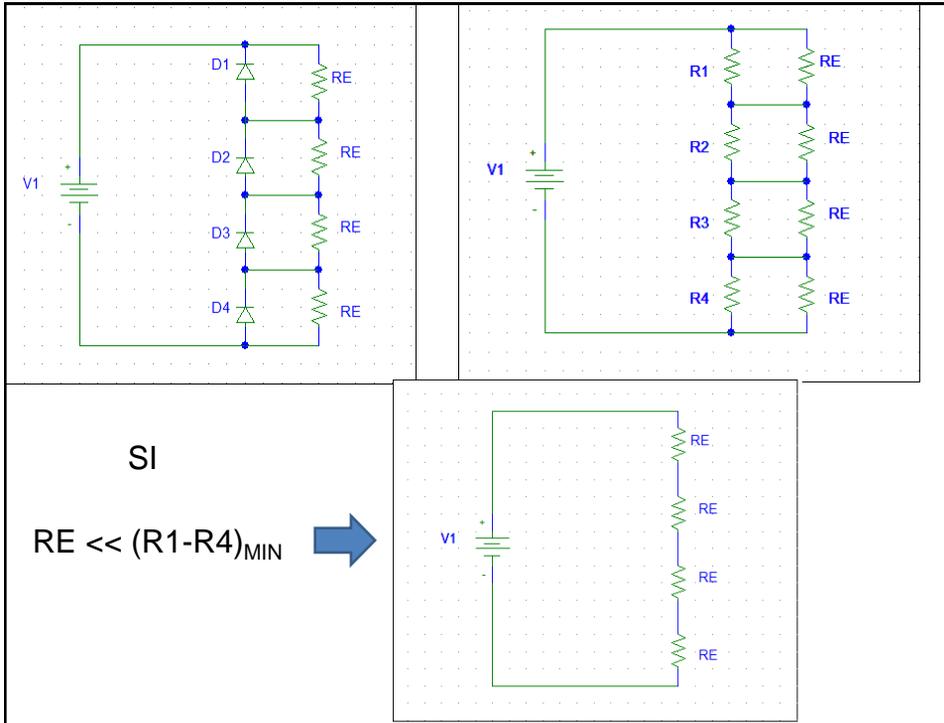


R_1 - R_4 representan la resistencia equivalente de los diodo D_1 - D_4 en inversa

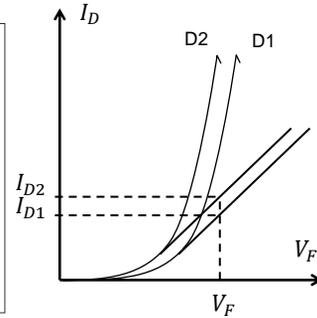
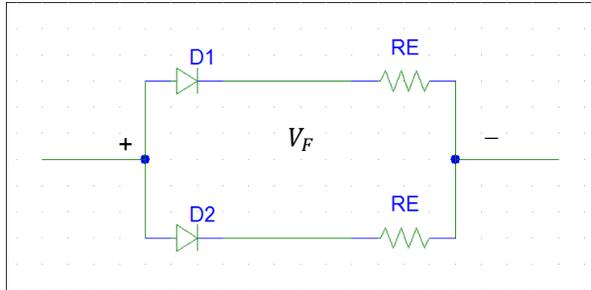
Si las resistencia no son iguales las tensiones en cada diodo no será igual

Ejemplo: Diodos de 1000 V de tensión inversa – Fuente 4000 V

La caída en alguno de los diodos será mayor que 1000 V

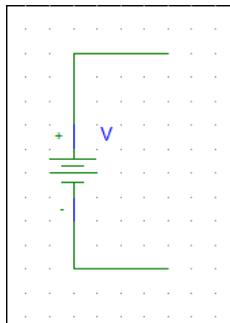


DIODOS Paralelo



$$RE \gg (R_{d1} - R_{d2})_{MAX}$$

REGULADOR DE TENSION

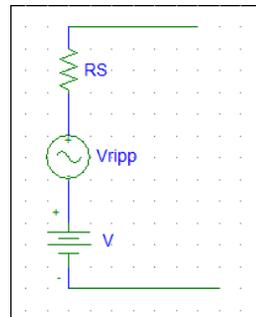


Fuente Ideal

$$R_S = 0$$

$$V_{Ripp} = 0$$

$$\Delta V = 0$$

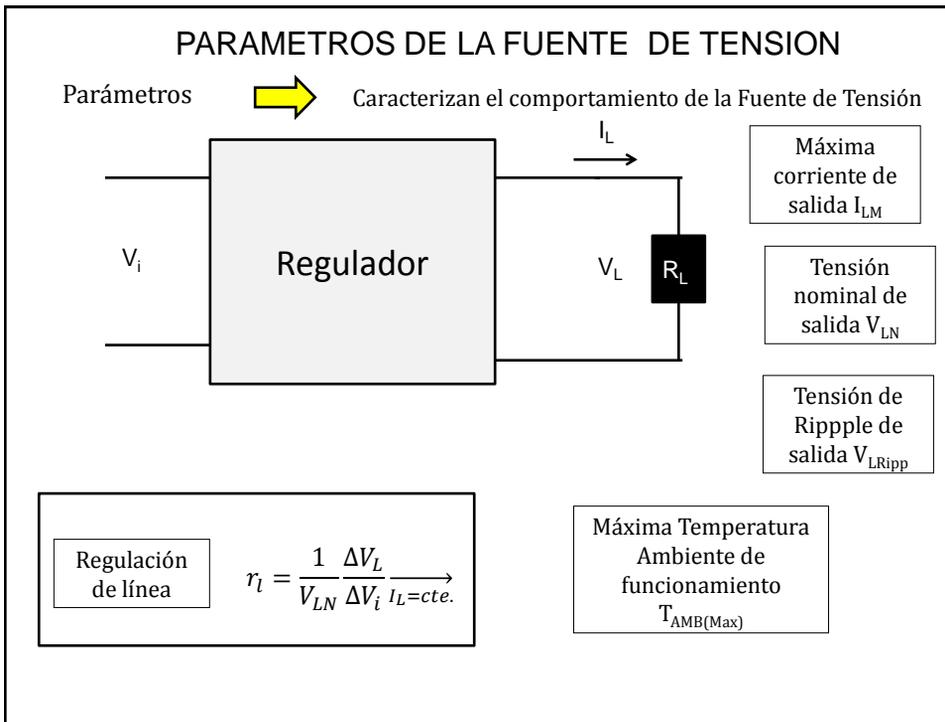
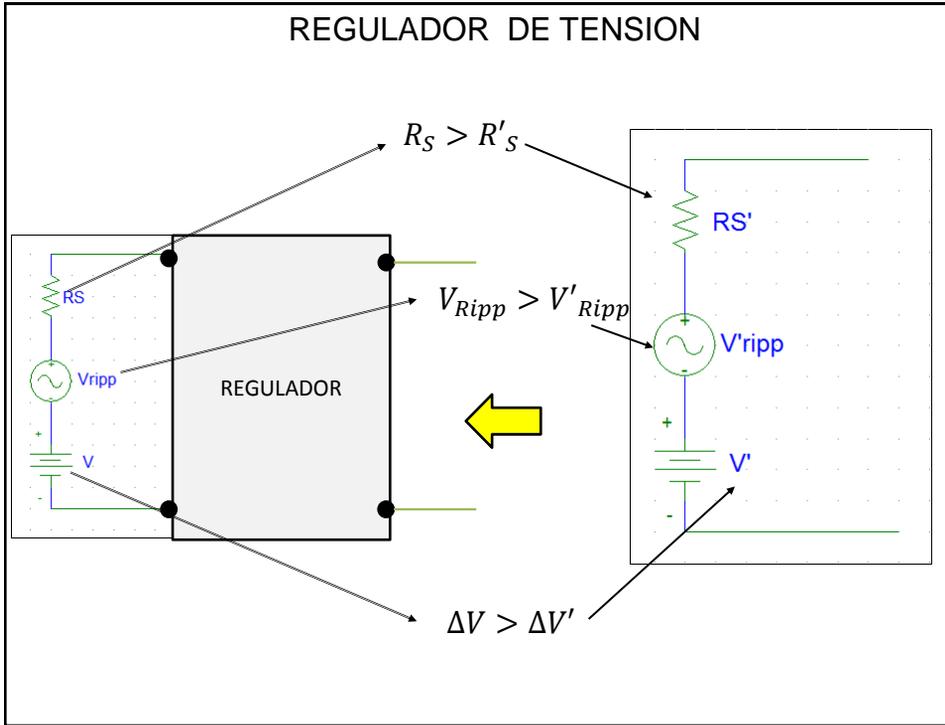


Fuente Real

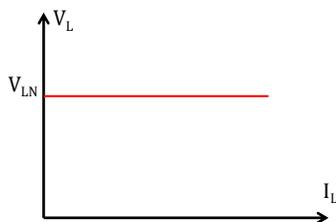
$$R_S \neq 0$$

$$V_{Ripp} \neq 0$$

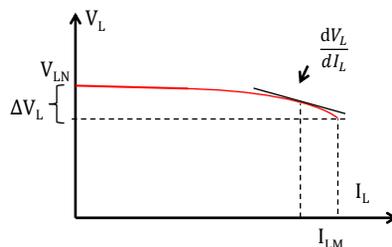
$$\Delta V \neq 0$$



PARAMETROS DE LA FUENTE DE TENSION



Fuente Ideal



Fuente Real

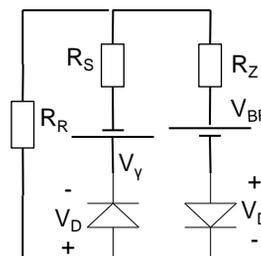
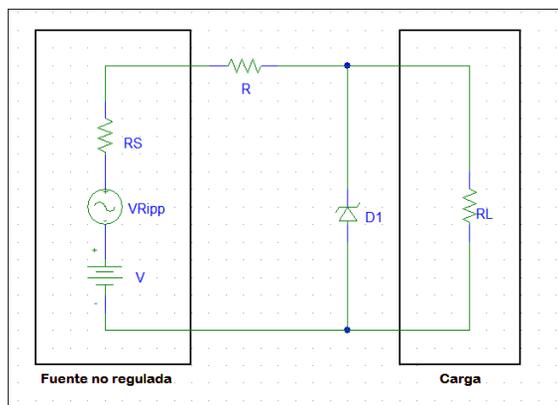
Regulación de carga

$$r_c = \frac{\Delta V_L}{V_L} \frac{v_i = \text{cte.}}{\frac{\Delta I_L}{I_L} = 100\%}$$

Resistencia de salida R_0

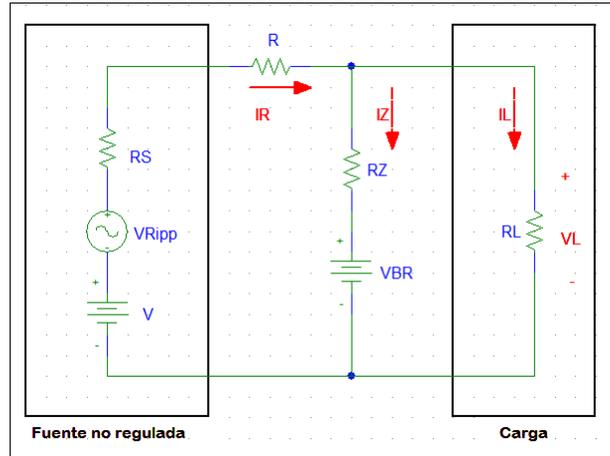
$$R_0 = \frac{dV_L}{dI_L} \frac{v_i = \text{cte.}}{I_L \sim I_{LM}}$$

Regulador con diodo ZENER



- Entre la Fuente no regulada y la carga conectamos la resistencia R y el diodo regulador (Zener) $D1$
- Si la tensión sobre el diodo es mayor que su tensión de bloqueo inverso V_{BR} podemos reemplazarlo por el modelo en conducción inversa

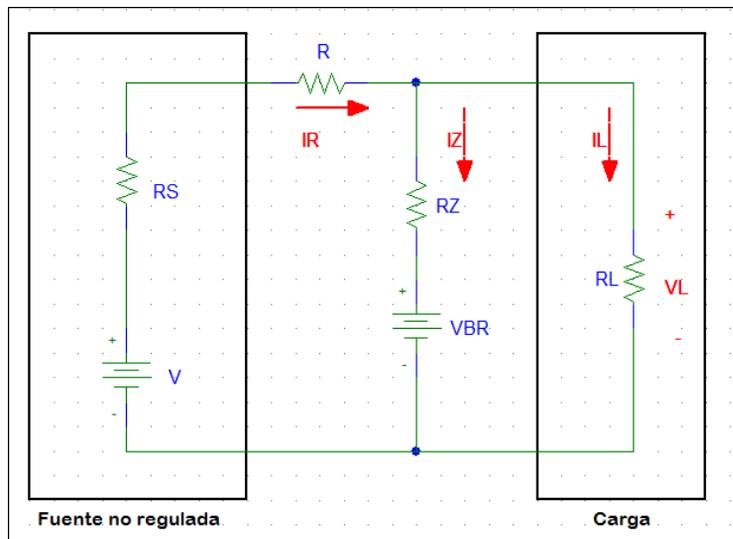
Regulador con diodo ZENER

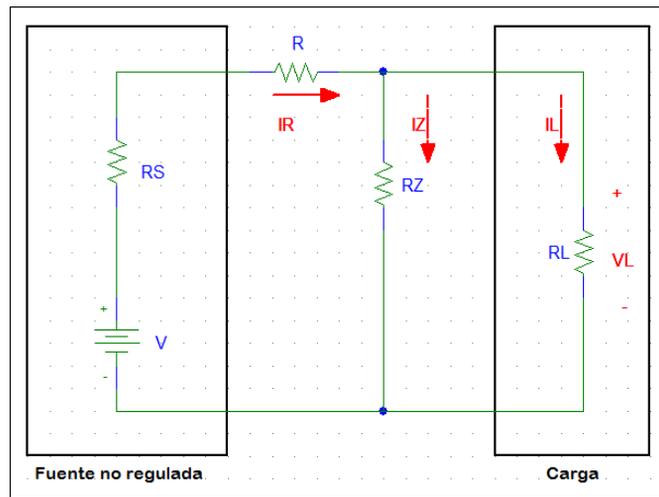


Circuito del regulador si $V > V_{BR}$

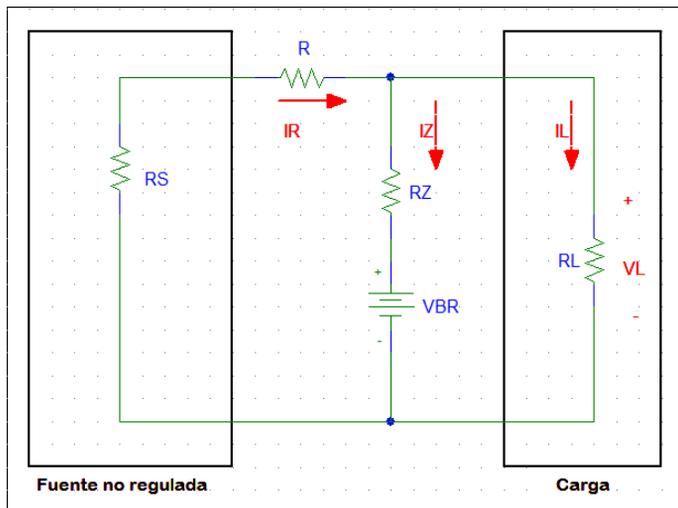
Usando el circuito calculamos

- V_L
- V_{LRipp}
- Regulación de carga
- Resistencia de salida

Circuito para calcular V_L 



$$V_{L1} = V \frac{R_Z // R_L}{(R_S + R + R_Z // R_L)}$$



$$V_{L2} = V_{BR} \frac{R_L // (R + R_S)}{(R_Z + R_L // (R + R_S))}$$

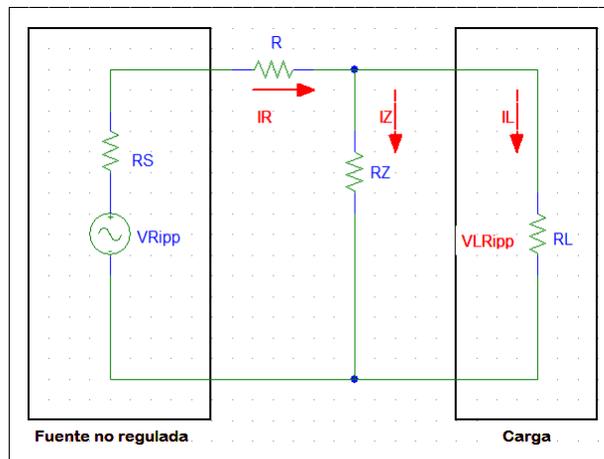
$$V_L = V_{L1} + V_{L2}$$

$$V_{L1} = V \frac{R_Z // R_L}{(R_S + R + R_Z // R_L)} \quad V_{L2} = V_{BR} \frac{R_L // (R + R_S)}{(R_Z + R_L // (R + R_S))}$$

$$\text{Si } R \gg R_S \text{ y } R_Z \quad \text{Si } R_L \gg R_Z \quad \text{Si } R_L \gg (R + R_S)$$

$$V_{L1} = V \frac{R_Z}{R} \quad V_{L2} = V_{BR}$$

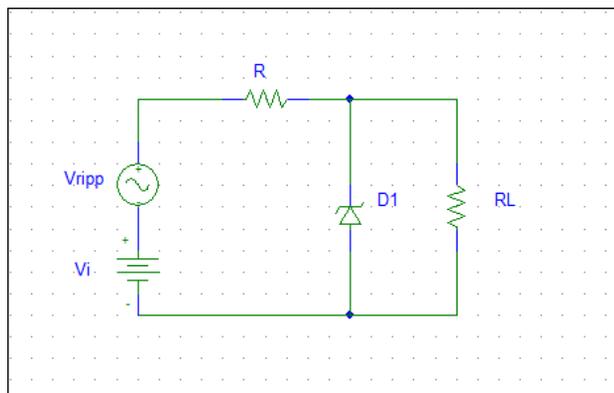
$$V_L = V_{BR} + V \frac{R_Z}{R}$$

Circuito para calcular V_{LRipp} 

$$V_{LRipp} = V_{Ripp} \frac{R_Z // R_L}{(R_S + R + R_Z // R_L)}$$

$$V_{LRipp} \approx V_{Ripp} \frac{R_Z}{R}$$

Regulador con diodo ZENER

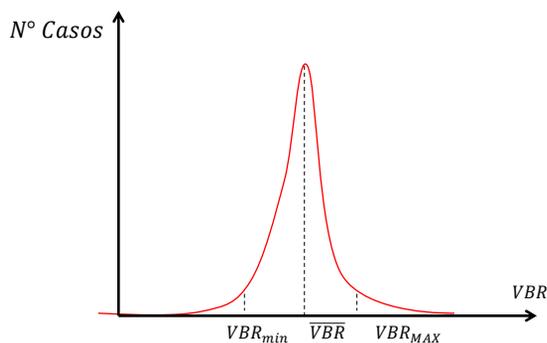


Diodos Reguladores

- Coeficiente termico
- Diferencia en las especificaciones con los rectificadores
- Hoja de datos de diodo Zener

Diodo Rectificador VS Diodo Regulador (ZENER)

- La misma fabricación
- Distintas zonas de trabajo
 - Rectificador $|V_{BR}| > V_D$
 - Regulador $|V_{BR}| < V_D$
- Distintas especificaciones en
 - Máximos Absolutos
 - Características Eléctricas





1N4728A to 1N4764A

Vishay Semiconductors

Silicon Power Zener Diodes

Features

- Silicon Planar Power Zener Diodes
- For use in stabilizing and clipping circuits with high power rating.
- Standard Zener voltage tolerance suffix "A" for $\pm 5\%$ tolerance. Other Zener voltages and tolerances are available upon request.



949369

Applications

Voltage stabilization

Mechanical Data

Case: DO-41 Glass Case

Weight: approx. 350 mg

Packaging Codes/Options:

TR / 5k per 13 " reel , 25k/box

TAP / 5k per Ammo mag. (52 mm tape), 25k/box

Absolute Maximum Ratings

$T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Power dissipation	$T_{amb} \leq 50\text{ }^{\circ}\text{C}$	P_{Diss}	1	W
Z-current		I_Z	P_V/V_Z	mA
Junction temperature		T_j	200	$^{\circ}\text{C}$
Storage temperature range		T_{stg}	-65 to +200	$^{\circ}\text{C}$
Junction ambient	$l = 9.5\text{ mm (3/8")}$, $T_L = \text{constant}$	P_{thJA}	100	K/W

1N4728A to 1N4764A

Vishay Semiconductors



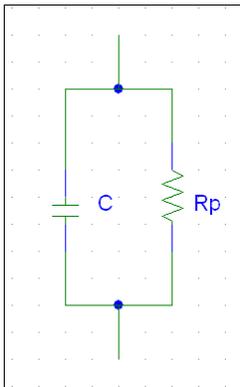
Electrical Characteristics

1N4728A...1N4764A

Partnumber	Nominal Zener Voltage ¹⁾		Maximum Dynamic Impedance			Maximum Reverse Leakage Current		Surge current	Maximum Regulator Current ²⁾
	$V_Z @ I_{ZT}$	I_{ZT}	$Z_{ZT} @ I_{ZT}$	$Z_{ZK} @ I_{ZK}$	I_{ZK}	I_R	Test Voltage V_R	$I_R @ T_{amb} = 25\text{ }^{\circ}\text{C}$	$I_{ZM} @ T_{amb} = 50\text{ }^{\circ}\text{C}$
	V	mA	Ω	Ω	mA	μA	V	mA	mA
1N4728A	3.3	76	10	400	1	100	1	1380	276
1N4729A	3.6	69	10	400	1	100	1	1260	252
1N4730A	3.9	64	9	400	1	50	1	1190	234
1N4731A	4.3	58	9	400	1	10	1	1070	217
1N4732A	4.7	53	8	500	1	10	1	970	193
1N4733A	5.1	49	7	550	1	10	1	890	178
1N4734A	5.6	45	5	600	1	10	2	810	162
1N4735A	6.2	41	2	700	1	10	3	730	146
1N4736A	6.8	37	0.5	700	1	10	4	660	133
1N4737A	7.5	34	0	700	0.5	10	5	605	121
1N4738A	8.2	31	0.5	700	0.5	10	6	550	110
1N4739A *	9.1	28	0	700	0.5	10	7	500	100
1N4740A *	10	25	7	700	0.25	10	7.6	454	91
1N4741A *	11	23	8	700	0.25	5	8.4	414	83
1N4742A *	12	21	9	700	0.25	5	9.1	380	76
1N4743A *	13	19	10	100	0.25	5	9.9	344	69
1N4744A *	15	17	14	700	0.25	5	11.4	304	61
1N4745A *	16	15.5	16	700	0.25	5	12.2	285	57
1N4746A *	18	14	20	750	0.25	5	13.7	260	50
1N4747A *	20	12.5	22	750	0.25	5	15.2	225	45
1N4748A *	22	11.5	23	750	0.25	5	16.7	205	41
1N4749A *	24	10.5	25	750	0.25	5	18.2	190	38
1N4750A *	27	9.5	35	750	0.25	5	20.6	170	34
1N4751A *	30	8.5	40	1000	0.25	5	22.8	150	30

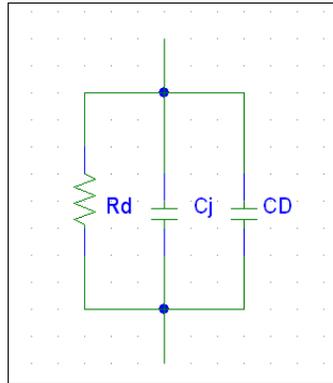
Diodo Varicap

Factor de Calidad (Q)
de un capacitor



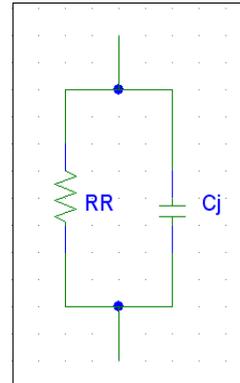
$$Q = \omega C R_p$$

Diodo en directo



$$R_d = U_T / I_D \approx 30 \text{ m}\Omega$$

Diodo en inverso



$$R_R \approx 100 \text{ M}\Omega$$

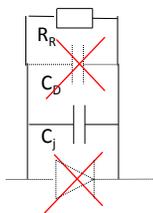
Capacidad de Juntura (Cj) vs Capacidad de Difusión (CD)

$$C_j \sim \text{pF} (10^{-12})$$

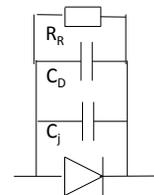
$$C_D \sim \mu\text{F} (10^{-6})$$

C_j esta presente siempre en
polarización directa e inversa

C_D solo esta presente en
polarización directa



$$Q \text{ (Factor de calidad)} = \omega C_j R_R$$



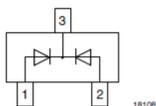
$$Q \text{ (Factor de calidad)} = \omega C_D (R_R \parallel r_d)$$



BB814-V-GH

Vishay Semiconductors

Dual Varicap Diode

**MECHANICAL DATA**

Case: SOT-23

Weight: approx. 8.1 mg

Packaging codes/options:

08/3 k per 7" reel (8 mm tape), 15 k/box

FEATURES

- Silicon epitaxial planar diode
- Common cathode
- AEC-Q101 qualified
- Compliant to RoHS directive 2002/95/EC and in accordance to WEEE 2002/96/EC
- Find out more about Vishay's Automotive Grade Product requirements at: www.vishay.com/applications

APPLICATIONS

- Tuning of separate resonant circuits
- Push-pull circuits in FM range
- Especially for car radios

AUTOMOTIVE
GRADERoHS
COMPLIANT
GREEN
[IS-9000]™

PARTS TABLE					
PART	TYPE DIFFERENTIATION	ORDERING CODE	TYPE MARKING	REMARKS	
BB814-1-V-GH	$V_{FRM} = 20\text{ V}$, $C_{D2} = 43\text{ pF}$ to 45.5 pF	BB814-1-V-GH-08	SG1	Tape and reel	
BB814-2-V-GH	$V_{FRM} = 20\text{ V}$, $C_{D2} = 44.5\text{ pF}$ to 46.5 pF	BB814-2-V-GH-08	SG2	Tape and reel	

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT
Repetitive peak reverse voltage		V_{FRM}	20	V
Reverse voltage		V_R	18	V
Forward current		I_F	50	mA

THERMAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT
Junction temperature		T_j	125	$^{\circ}\text{C}$
Storage temperature range		T_{stg}	-55 to +150	$^{\circ}\text{C}$

ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

PARAMETER	TEST CONDITIONS	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Reverse current	$V_R = 16\text{ V}$		I_R			20	nA
	$V_R = 16\text{ V}$, $T_j = 60\text{ }^{\circ}\text{C}$		I_R			200	nA
Diode capacitance ⁽¹⁾	$V_R = 2\text{ V}$	BB814-1-V-GH	C_{D2}	43		45.5	pF
		BB814-2-V-GH	C_{D2}	44.5		46.5	pF
	$V_R = 8\text{ V}$	BB814-1-V-GH	C_{D8}	19.1		21.95	pF
		BB814-2-V-GH	C_{D8}	19.75		22.70	pF
Capacitance ratio	$V_R = 2\text{ V}$, 8 V , $f = 1\text{ MHz}$		C_{D2}/C_{D8}	2.05		2.25	
Series resistance	$C_D = 38\text{ pF}$, $f = 100\text{ MHz}$		R_s			0.5	Ω

Note

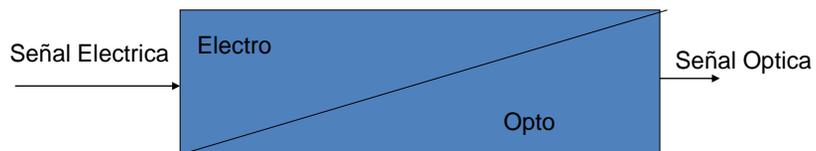
⁽¹⁾ In the reverse voltage range of $V_R = (2\text{ V to } 8\text{ V})$ for diodes 4 taped in sequence the max. deviation is 3 %

DIODOS EMISORES DE LUZ (LED'S)



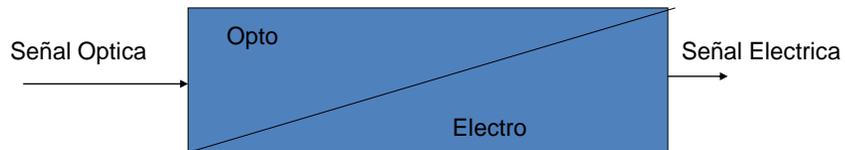
OPTOELECTRONICA

- Conversión electro optica

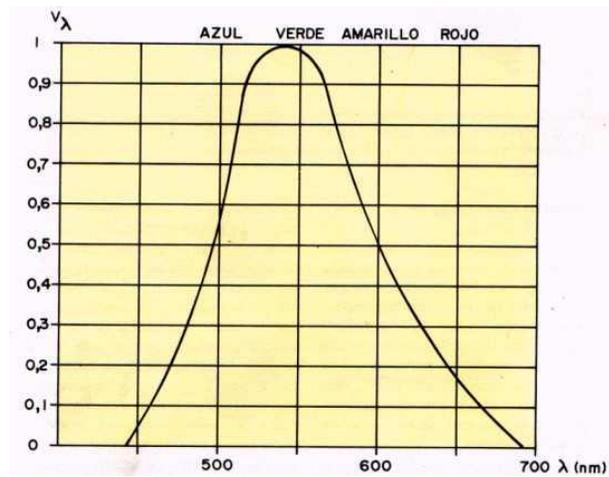


OPTOELECTRONICA

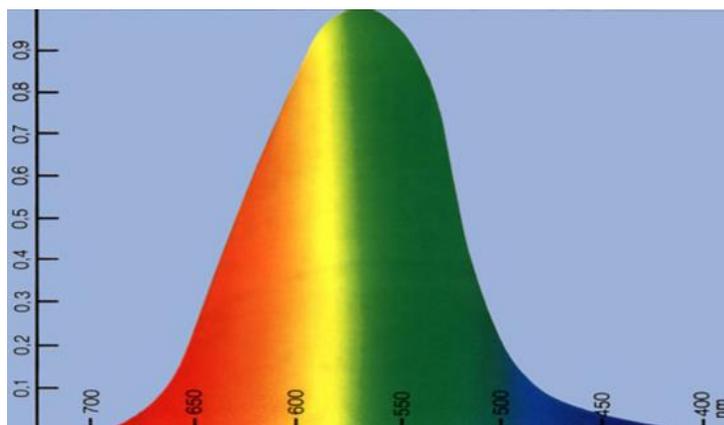
- Conversión óptica eléctrica



Sensibilidad del ojo humano

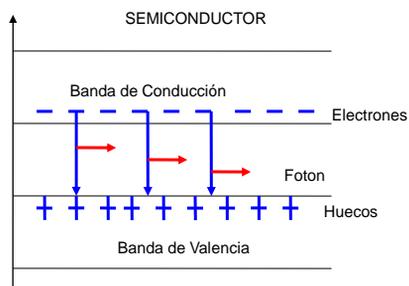


Sensibilidad del ojo humano



GENERACION DE FOTONES

- Fenómeno de recombinación de electrones de la banda de Conducción con huecos de la banda de Valencia
- Si el semiconductor es del tipo Directo se genera un Fotón desapareciendo el electrón y el hueco
 - El ARSENIURO DE GALIO GaAs es del tipo Directo
 - El Silicio Si es del tipo Indirecto, la recombinación de electrones de la banda de conducción con huecos de la banda de Valencia genera Fonones (Calor)

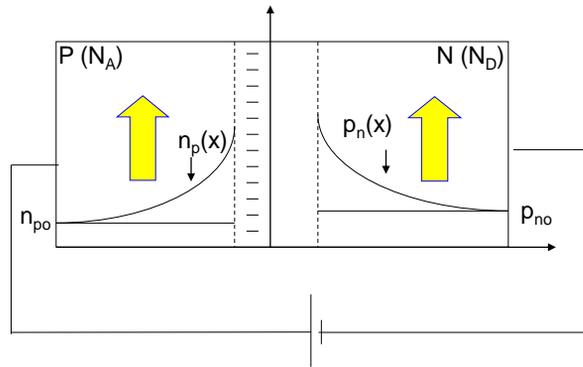


LED Light Emitting Diode

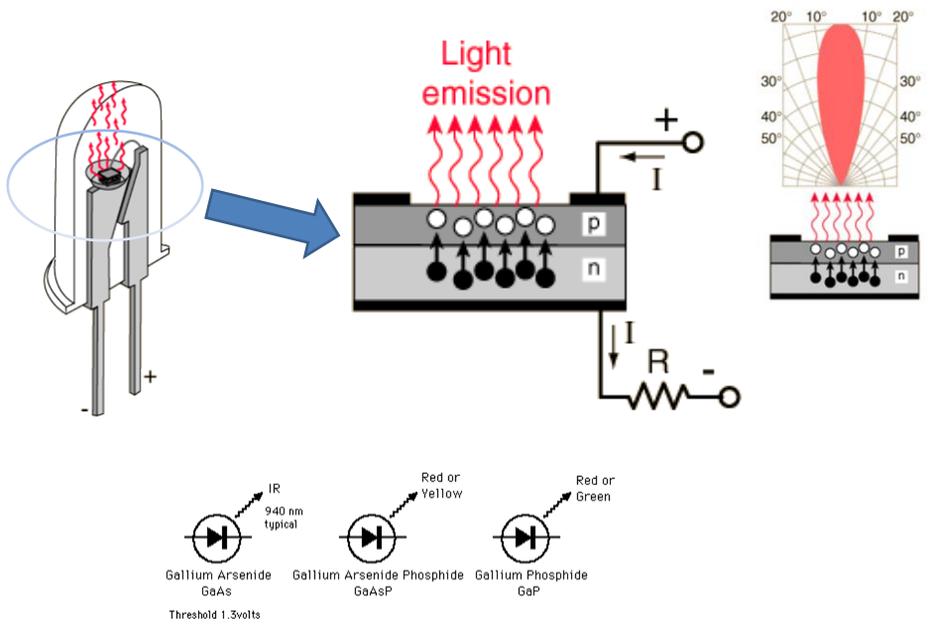
Conversión Electro - Optica



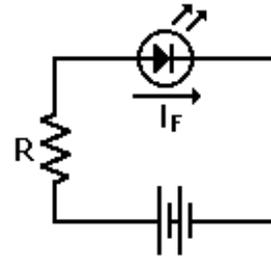
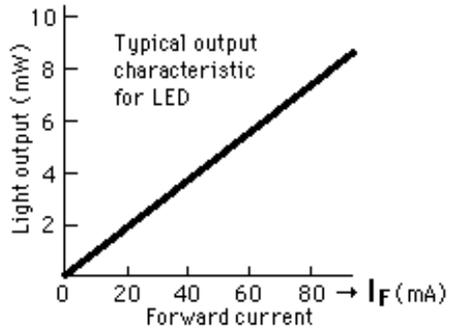
- Juntura PN polarizada directa para favorecer el fenómeno de recombinación en zonas neutras



ESTRUCTURA DEL DIODO LED

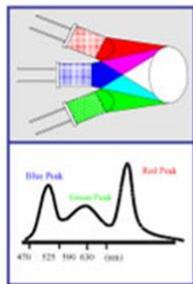


EMISION DE LUZ vs IF



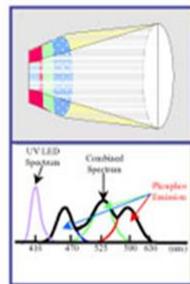
Generating White Light with LEDs

Red + Green + Blue LEDs



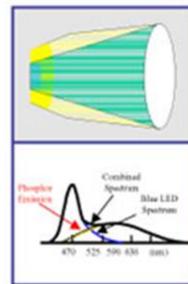
- Dynamic color tuning
- Excellent color rendering
- Large color gamut

UV LED + RGB Phosphor



- White point tunable by phosphors
- Excellent color rendering
- Simple to create white

Blue LED + Yellow Phosphor



- Simple to create white
- Good color rendering

There are various ways to create white light from LEDs, each with specific advantages.



TLHG420., TLHO420., TLHR420., TLHY420.

Vishay Semiconductors

High Efficiency LED, Ø 3 mm Tinted Undiffused Package



FEATURES

- Choice of five bright colors
- Standard T-1 package
- Small mechanical tolerances
- Suitable for DC and high peak current
- Wide viewing angle
- Luminous intensity categorized
- Yellow and green color categorized
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/E



RoHS
COMPLIANT
GREEN
IS-85361**

DESCRIPTION

The TLH.42. series was developed for standard applications like general indicating and lighting purposes.

It is housed in a 3 mm tinted clear plastic package. The wide viewing angle of these devices provides a high on-off contrast.

Several selection types with different luminous intensities are offered. All LEDs are categorized in luminous intensity groups. The green and yellow LEDs are categorized additionally in wavelength groups.

That allows users to assemble LEDs with uniform appearance.

APPLICATIONS

- Status lights
- Off/On indicator
- Background illumination
- Readout lights
- Maintenance lights
- Legend light

PRODUCT GROUP AND PACKAGE DATA

- Product group: LED
- Package: 3 mm
- Product series: standard
- Angle of half intensity: $\pm 22^\circ$

PARTS TABLE

PART	COLOR, LUMINOUS INTENSITY	TECHNOLOGY
TLHR4200	Red, $I_V > 4$ mcd	GaAsP on GaP
TLHR4201	Red, $I_V > 6.3$ mcd	GaAsP on GaP
TLHR4201-AS12Z	Red, $I_V > 6.3$ mcd	GaAsP on GaP
TLHR4205	Red, $I_V > 10$ mcd	GaAsP on GaP
TLHR4205-AS12	Red, $I_V > 10$ mcd	GaAsP on GaP
TLHR4205-AS12Z	Red, $I_V > 10$ mcd	GaAsP on GaP
TLHO4200	Soft orange, $I_V > 4$ mcd	GaAsP on GaP
TLHO4200-AS12Z	Soft orange, $I_V > 4$ mcd	GaAsP on GaP
TLHO4201	Soft orange, $I_V > 10$ mcd	GaAsP on GaP
TLHY4200	Yellow, $I_V > 4$ mcd	GaAsP on GaP
TLHY4200-AS12Z	Yellow, $I_V > 4$ mcd	GaAsP on GaP
TLHY4201	Yellow, $I_V > 6.3$ mcd	GaAsP on GaP
TLHY4201-AS21	Yellow, $I_V > 6.3$ mcd	GaAsP on GaP
TLHY4201-MS12Z	Yellow, $I_V > 6.3$ mcd	GaAsP on GaP
TLHY4205	Yellow, $I_V > 10$ mcd	GaAsP on GaP
TLHY4205-BT12Z	Yellow, $I_V > 10$ mcd	GaAsP on GaP
TLHY4205-LS21	Yellow, $I_V > 10$ mcd	GaAsP on GaP
TLHY4205-LS21Z	Yellow, $I_V > 10$ mcd	GaAsP on GaP
TLHY4205-MS12	Yellow, $I_V > 10$ mcd	GaAsP on GaP
TLHG4200	Green, $I_V > 6.3$ mcd	GaP on GaP
TLHG4200-AS12	Green, $I_V > 6.3$ mcd	GaP on GaP
TLHG4200-AS12Z	Green, $I_V > 6.3$ mcd	GaP on GaP
TLHG4200-AS21	Green, $I_V > 6.3$ mcd	GaP on GaP

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)
TLHG420., TLHO420., TLHR420., TLHY420.

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage ¹⁾		V_R	6	V
DC forward current		I_F	30	mA
Surge forward current	$t_p \leq 10\text{ }\mu\text{s}$	I_{FSM}	1	A
Power dissipation		P_V	100	mW
Junction temperature		T_J	100	$^{\circ}\text{C}$
Operating temperature range		T_{amb}	- 40 to + 100	$^{\circ}\text{C}$
Storage temperature range		T_{stg}	- 55 to + 100	$^{\circ}\text{C}$
Soldering temperature	$t \leq 5\text{ s}$, 2 mm from body	T_{sd}	260	$^{\circ}\text{C}$
Thermal resistance junction/ ambient		R_{thJA}	400	K/W

Note:
¹⁾ Driving the LED in reverse direction is suitable for a short term application

OPTICAL AND ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)
TLHR420., RED

PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Luminous intensity	$I_F = 10\text{ mA}$	TLHR4200	I_V	4	8		mod
		TLHR4201	I_V	6.3	10		mod
		TLHR4205	I_V	10	15		mod
Dominant wavelength	$I_F = 10\text{ mA}$		λ_d	612		625	nm
Peak wavelength	$I_F = 10\text{ mA}$		λ_p		635		nm
Angle of half intensity	$I_F = 10\text{ mA}$		φ		± 22		deg
Forward voltage	$I_F = 20\text{ mA}$		V_F		2	3	V
Reverse current	$V_R = 6\text{ V}$		I_R			10	μA
Junction capacitance	$V_R = 0, f = 1\text{ MHz}$		C_J		50		pF



TLHG420., TLHO420., TLHR420., TLHY420.
 Vishay Semiconductors

TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

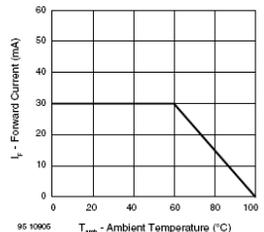


Figure 1. Forward Current vs. Ambient Temperature

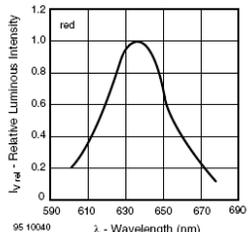


Figure 4. Relative Intensity vs. Wavelength

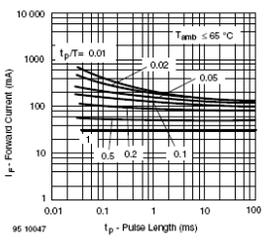


Figure 2. Forward Current vs. Pulse Length

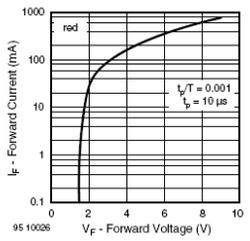


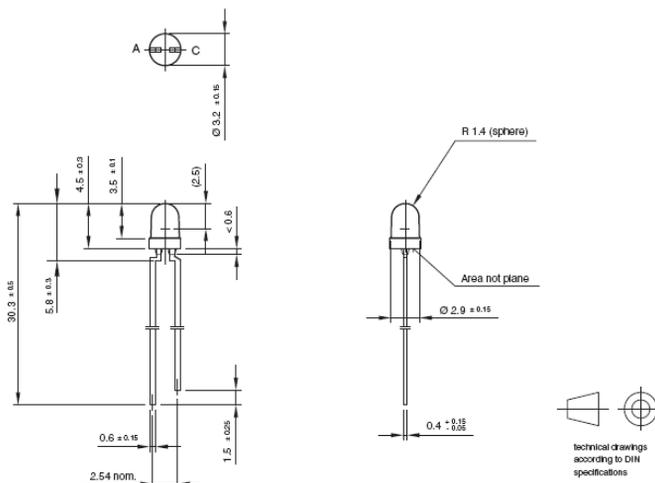
Figure 5. Forward Current vs. Forward Voltage



TLHG420., TLHO420., TLHR420., TLHY420.

Vishay Semiconductors

PACKAGE DIMENSIONS in millimeters

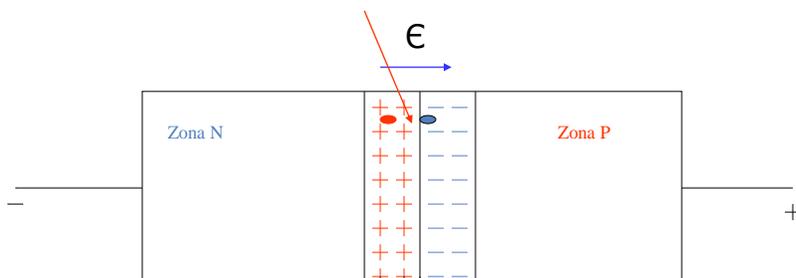


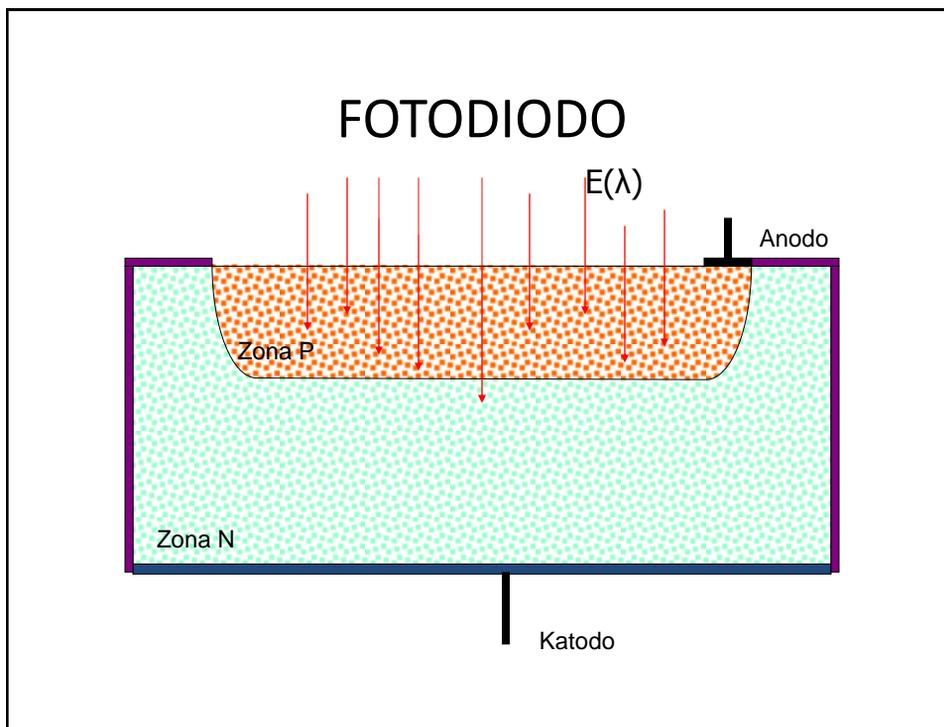
EFECTO FOTOELECTRICO DE JUNTURA

Conversión
Óptica -Electro



- Junta PN polarizada inversa para favorecer el fenómeno de generación en zona de deplexion





www.vishay.com

BPW20RF

Vishay Semiconductors

Silicon Photodiode, RoHS Compliant



DESCRIPTION

BPW20RF is a planar Silicon PN photodiode in a hermetically sealed short TO-5 case, especially designed for high precision linear applications.

Due to its extremely high dark resistance, the short circuit photocurrent is linear over seven decades of illumination level.

On the other hand, there is a strictly logarithmic correlation between open circuit voltage and illumination over the same range.

Equipped with a clear, flat glass window, the spectral responsivity reaches from blue to near infrared.

FEATURES

- Package type: leaded
- Package form: TO-5
- Dimensions (in mm): \varnothing 8.13
- Radiant sensitive area (in mm²): 7.5
- High photo sensitivity
- High radiant sensitivity
- Suitable for visible and near infrared radiation
- Angle of half sensitivity: $\varphi = \pm 50^\circ$
- Hermetically sealed package
- Cathode connected to package
- Flat glass window
- UV enhanced
- Low dark current
- High shunt resistance
- High linearity
- Compliant to RoHS Directive 2002/95/EC and in accordance with WEEE 2002/96/EC



RoHS
COMPLIANT

APPLICATIONS

- Sensor for light measuring techniques in cameras, photometers, color analyzers, exposure meters (e.g. solariums) and other medical and industrial measuring and control applications.

PRODUCT SUMMARY			
COMPONENT	I_{ra} (μA)	φ (deg)	$\lambda_{0.1}$ (nm)
BPW20RF	60	± 50	400 to 1100

Note

- Test condition see table "Basic Characteristics"

ORDERING INFORMATION			
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM
BPW20RF	Bulk	MOQ: 500 pcs, 500 pcs/bulk	TO-5

Note

- MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25\text{ }^{\circ}C$, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		V_R	10	V
Power dissipation	$T_{amb} \leq 50\text{ }^{\circ}C$	P_V	300	mW
Junction temperature		T_J	125	$^{\circ}C$
Operating temperature range		T_{amb}	- 40 to + 125	$^{\circ}C$
Storage temperature range		T_{stg}	- 40 to + 125	$^{\circ}C$
Soldering temperature	$t \leq 5\text{ s}$	T_{sd}	260	$^{\circ}C$
Thermal resistance junction/ambient	Connected with Cu wire, 0.14 mm ²	$R_{\theta JA}$	250	K/W

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Document Number: 81570



BPW20RF

Vishay Semiconductors

BASIC CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}C$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_F = 50\text{ mA}$	V_F		1.0	1.3	V
Breakdown voltage	$I_R = 20\text{ }\mu A$, $E = 0$	$V_{(BR)}$	10			V
Reverse dark current	$V_R = 5\text{ V}$, $E = 0$	I_{r0}		2	30	nA
Diode capacitance	$V_R = 0\text{ V}$, $f = 1\text{ MHz}$, $E = 0$	C_D		1.2		nF
	$V_R = 5\text{ V}$, $f = 1\text{ MHz}$, $E = 0$	C_D		400		pF
Dark resistance	$V_R = 10\text{ mV}$	R_D		38		$G\Omega$
Open circuit voltage	$E_A = 1\text{ klx}$	V_o	330	500		mV
Temperature coefficient of V_o	$E_A = 1\text{ klx}$	TK_{V_o}		- 2		mV/K
Short circuit current	$E_A = 1\text{ klx}$	I_k	20	60		μA
Temperature coefficient of I_k	$E_A = 1\text{ klx}$	TK_{I_k}		0.1		%/K
Reverse light current	$E_A = 1\text{ klx}$, $V_R = 5\text{ V}$	I_{ra}	20	60		μA
	$E_A = 1\text{ mW/cm}^2$, $\lambda = 950\text{ nm}$, $V_R = 5\text{ V}$	I_{ra}		42		μA
Angle of half sensitivity		φ		± 50		deg
Wavelength of peak sensitivity		λ_p		920		nm
Range of spectral bandwidth		$\lambda_{0.1}$	400		1100	nm
Rise time	$V_R = 0\text{ V}$, $R_L = 1\text{ k}\Omega$, $\lambda = 820\text{ nm}$	t_r		3.4		μs
Fall time	$V_R = 0\text{ V}$, $R_L = 1\text{ k}\Omega$, $\lambda = 820\text{ nm}$	t_f		3.7		μs

BASIC CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

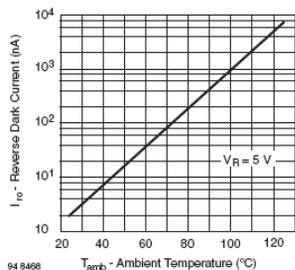


Fig. 1 - Reverse Dark Current vs. Ambient Temperature

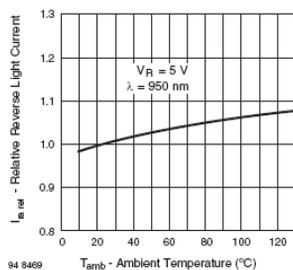


Fig. 2 - Relative Reverse Light Current vs. Ambient Temperature

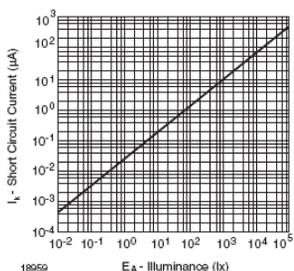


Fig. 3 - Short Circuit Current vs. Illuminance

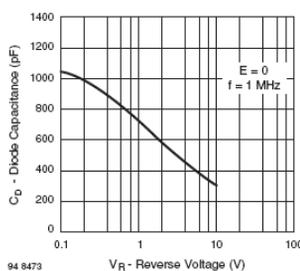


Fig. 6 - Diode Capacitance vs. Reverse Voltage

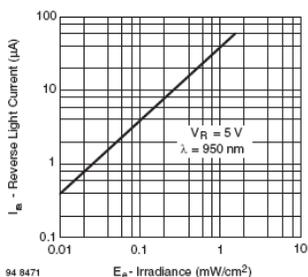


Fig. 4 - Reverse Light Current vs. Irradiance

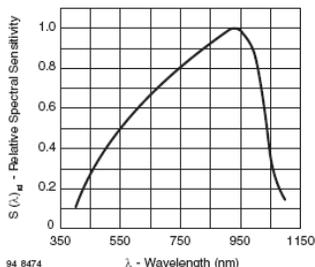


Fig. 7 - Relative Spectral Sensitivity vs. Wavelength

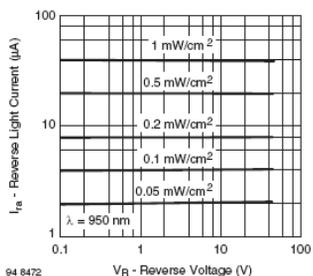


Fig. 5 - Reverse Light Current vs. Reverse Voltage

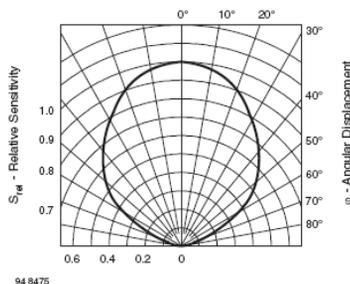


Fig. 8 - Relative Radiant Sensitivity vs. Angular Displacement

PACKAGE DIMENSIONS in millimeters

